

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	250	V
Working Peak Reverse Voltage	V _{RWM}	200	V
DC Blocking Voltage	V _R		V
RMS Reverse Voltage	V _{R(RMS)}	141	V
Forward Continuous Current (Notes 6, 8)	I _{FM}	400	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	9.0	A
		3.0	
		1.7	
Repetitive Peak Forward Surge Current (Note 6)	I _{FRM}	625	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	350	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	250	—	V	I _R = 100μA
Forward Voltage	V _F	—	1.0	V	I _F = 100mA
		—	1.25		I _F = 200mA
Reverse Current (Note 7)	I _R	—	100	nA	V _R = 200V, T _J = +25°C
		—	100	μA	V _R = 200V, T _J = +150°C
Total Capacitance	C _T	—	5.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{RR}	—	50	ns	I _F = I _R = 30mA, I _{RR} = 0.1 x I _R , R _L = 100Ω

Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 7. Short duration pulse test used to minimize self-heating effect.
 8. Double Diode Loaded in Parallel. For Single Diode or Double Diode Loaded in Series, the continuous forward current should be reduced by half.

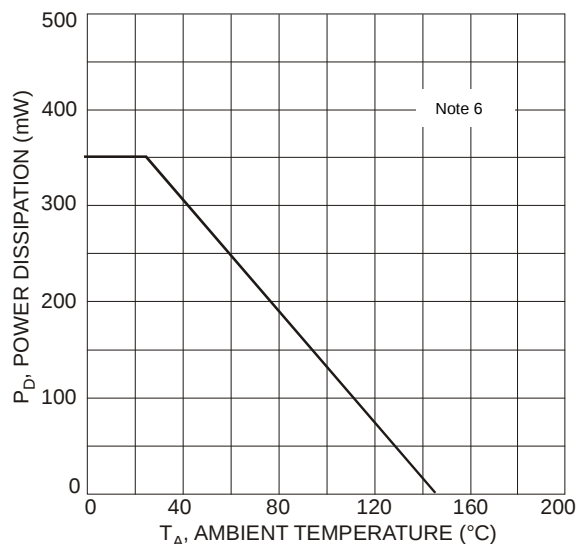


Fig. 1 Power Derating Curve, Total Package

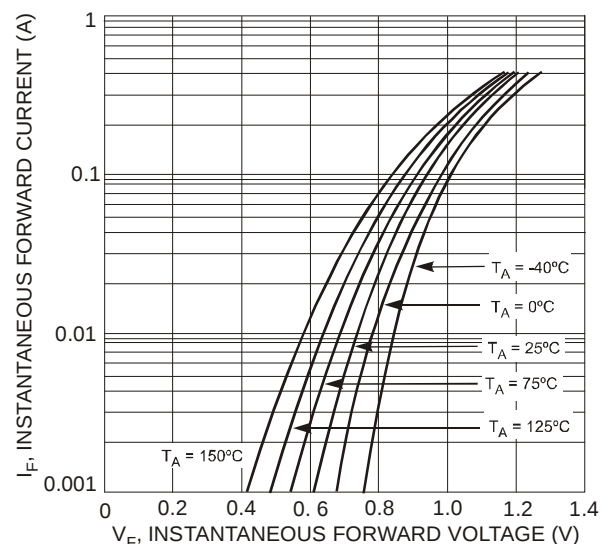


Fig. 2 Typical Forward Characteristics, Per Element

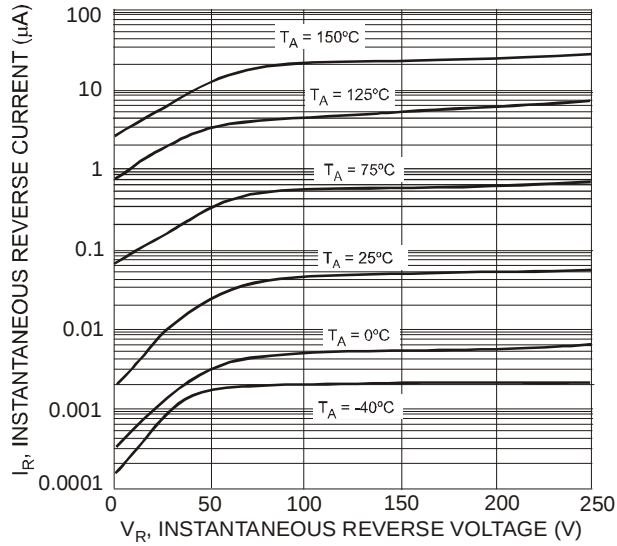


Fig. 3 Typical Reverse Characteristics, Per Element

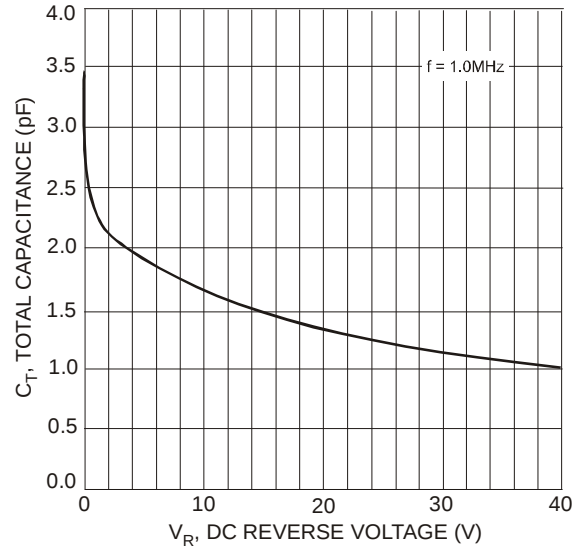
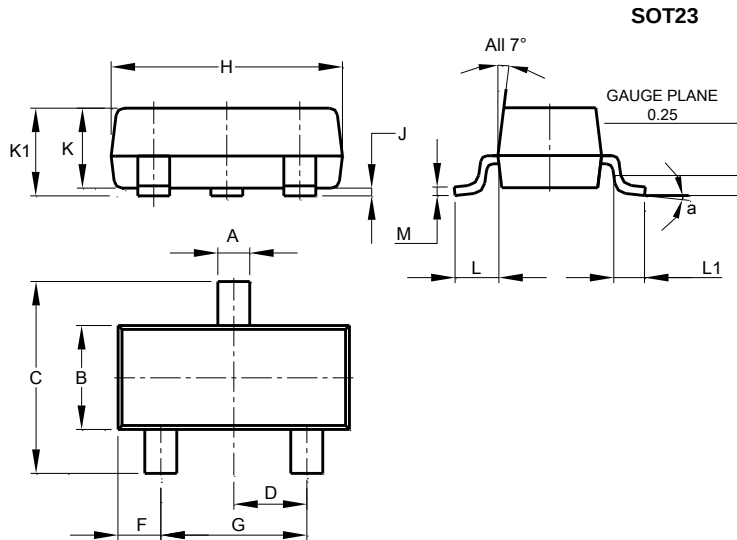


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

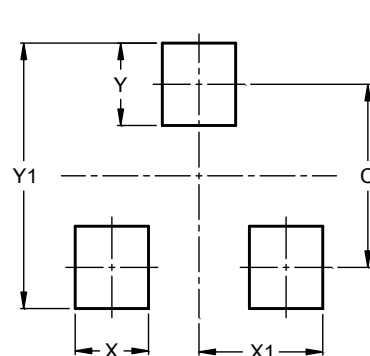
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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